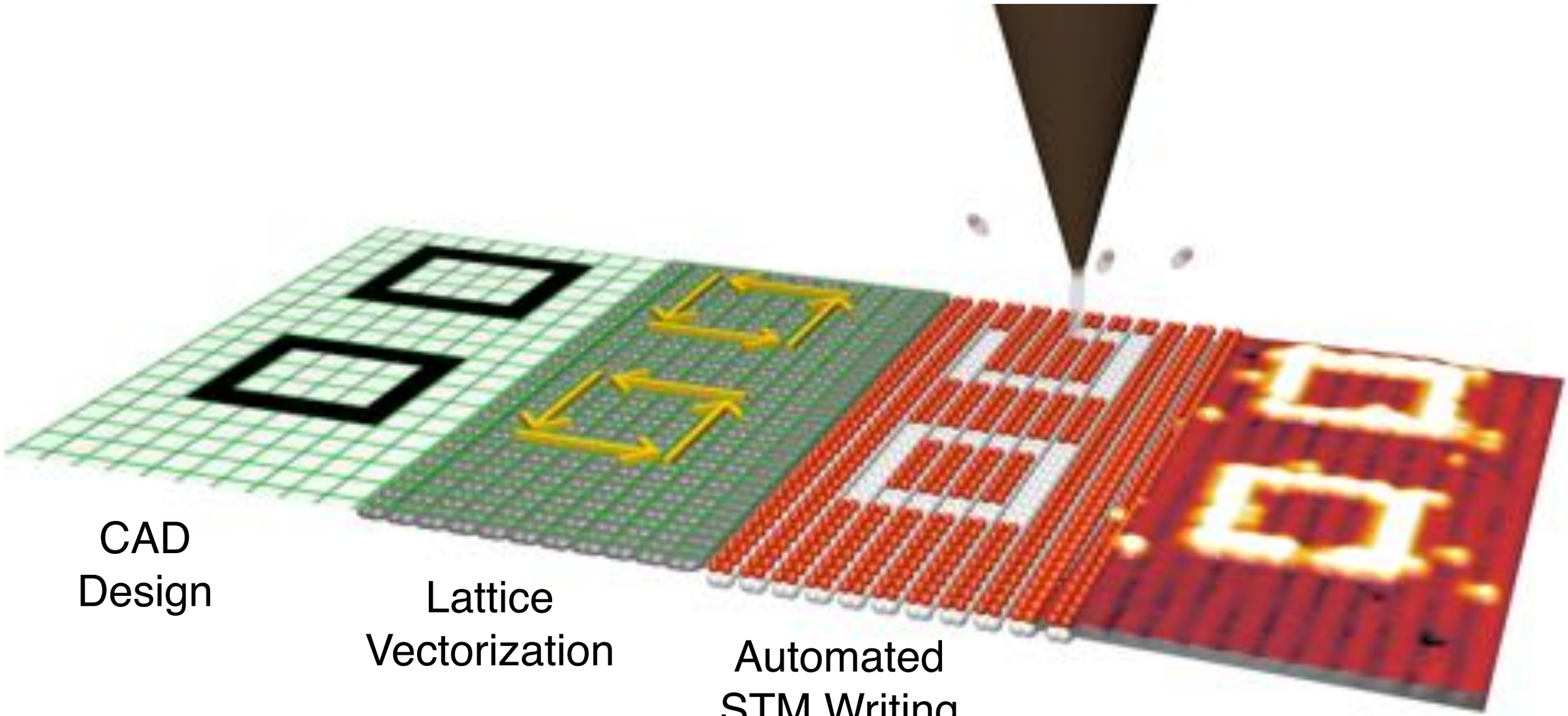
ZyVector™: controlling STM Lithography



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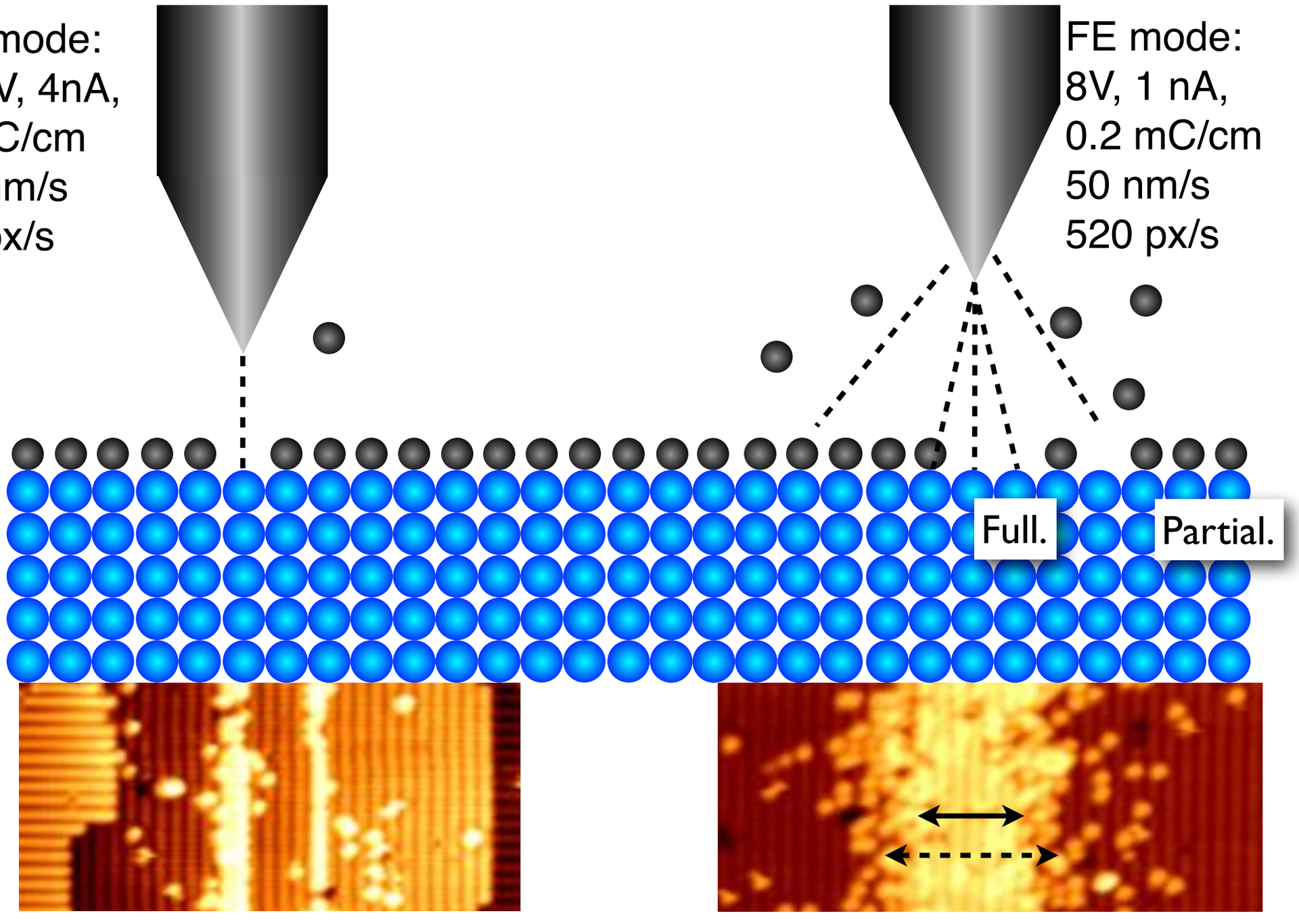
www.zyvexlabs.com

scientaomicron

What is STM Lithography?

AP mode:
4.5 V, 4nA,
2 mC/cm
20 nm/s
26 px/s

FE mode:
8V, 1 nA,
0.2 mC/cm
50 nm/s
520 px/s



An STM creates patterns by removing H atoms from a Si(001) surface.

The ZyVector System

- The ZyVector system hardware comprises:
  - 20-bit Digital Controller for STM feedback loop control, and real-time creep and hysteresis correction for sub-nm tip position precision.
  - high-voltage amplifier piezo drivers, with connections to a ScientaOmicron STM.
- The ZyVector software, Scanz, is optimized for automated STM lithography.

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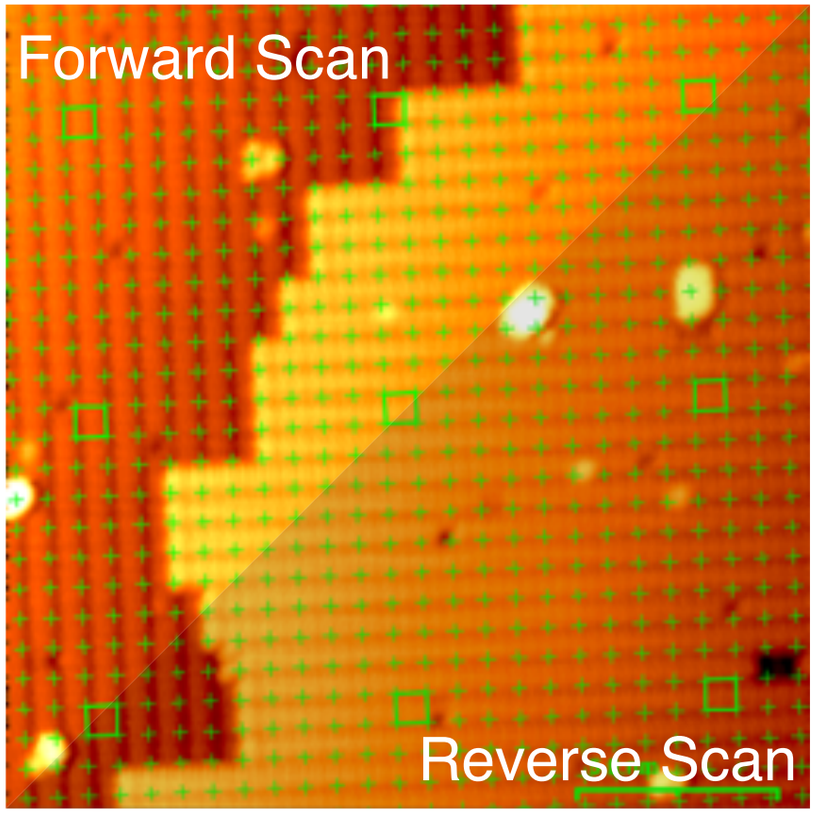
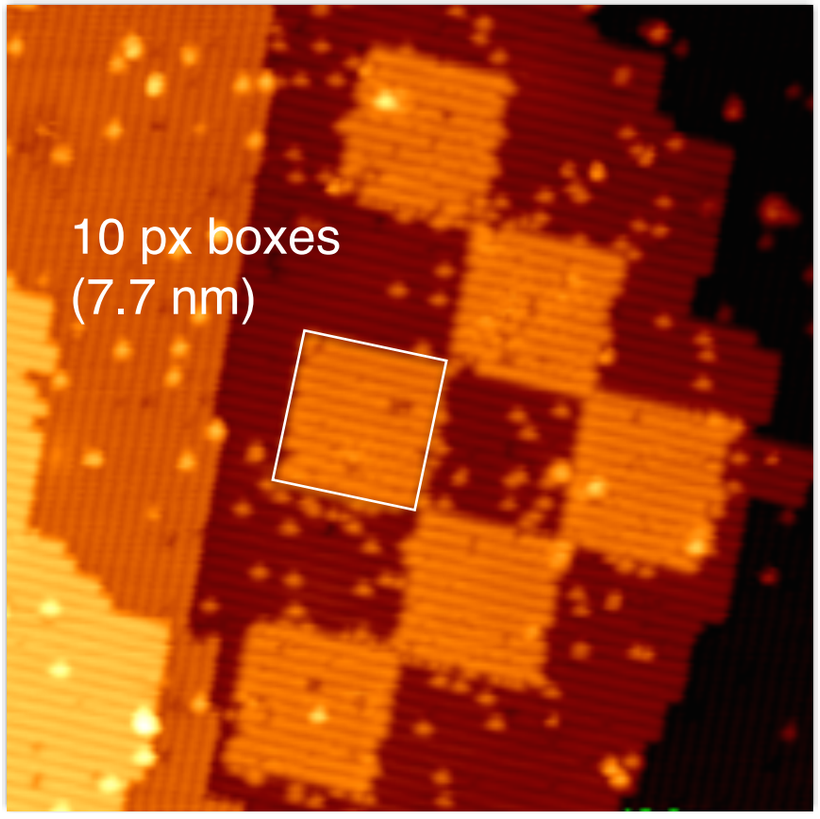
ZyVector Features



Distortion-free Imaging

Automatic pattern alignment to atomic lattice



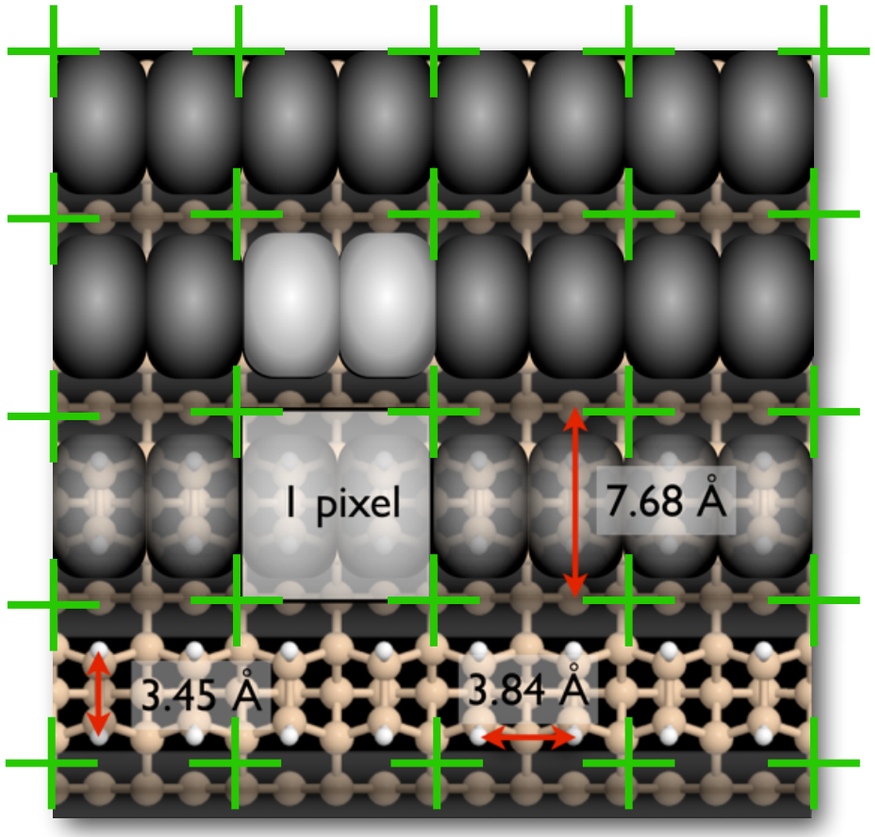
Precise Tip Motion

Atomic Resolution Patterns Made Easy

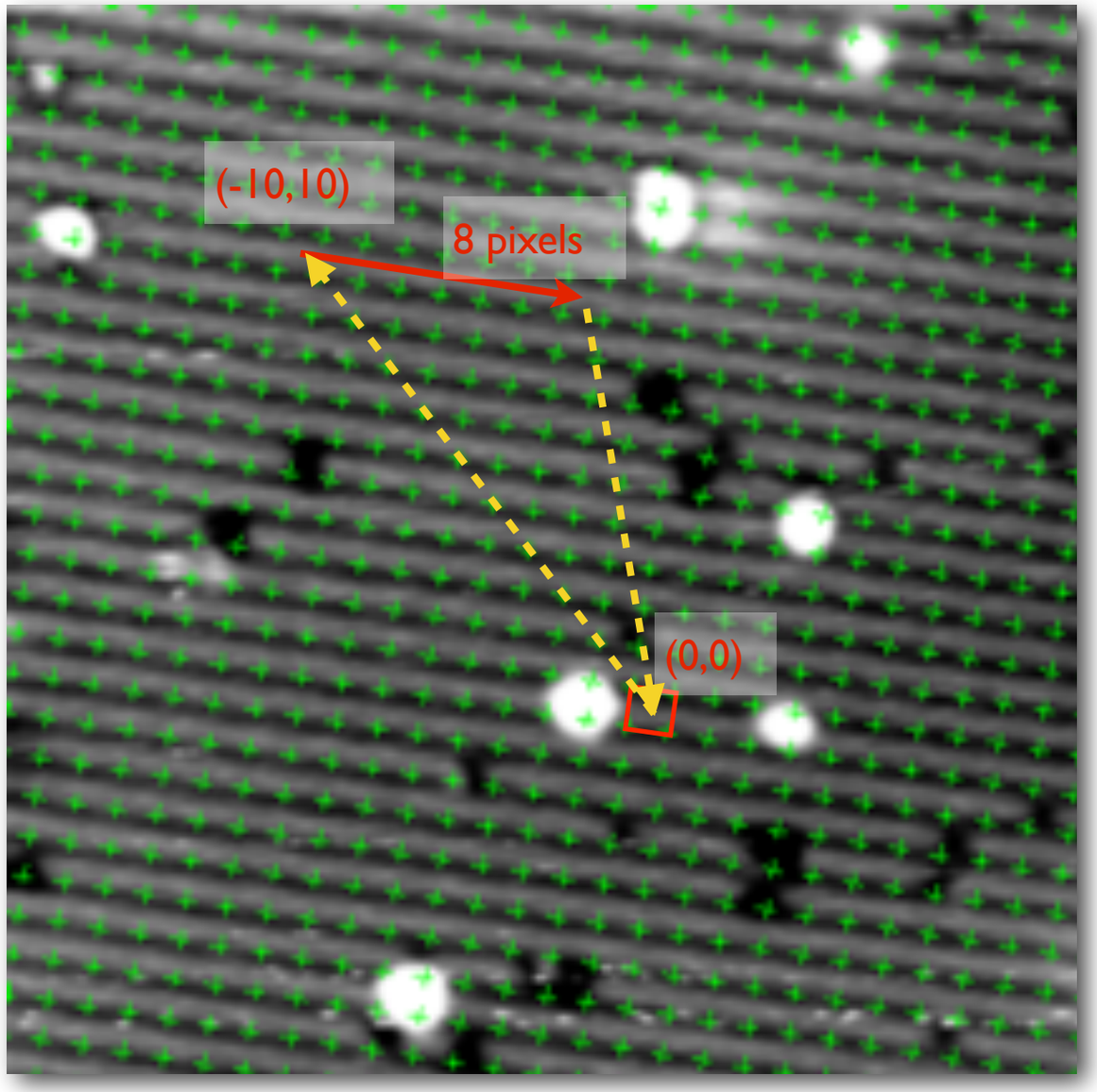
Patterning from CAD files

Automation of complex tasks through Scripting

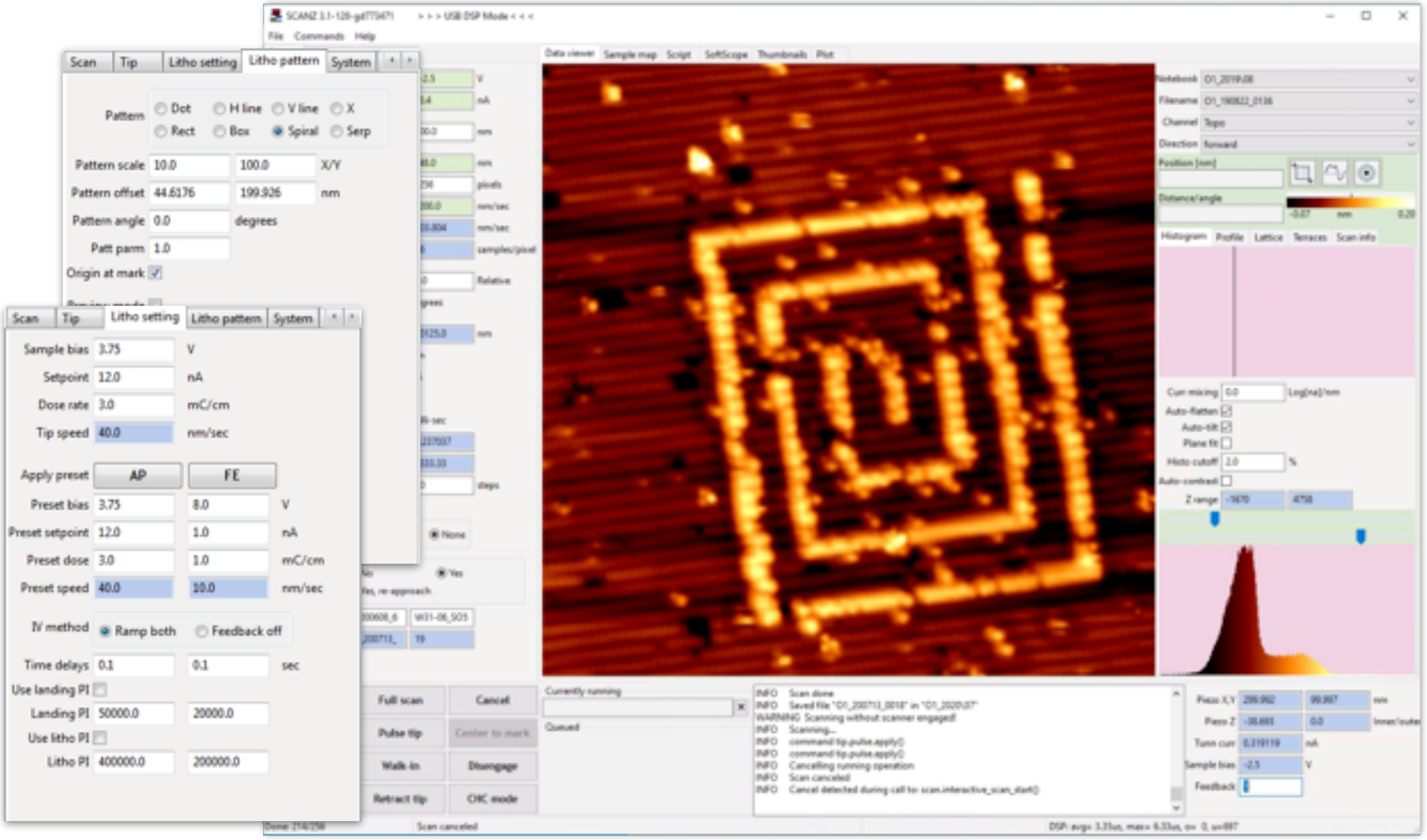
Digital Vector Patterning



The lithography pixel; 2 dimers on a dimer row, 0.768 nm wide.

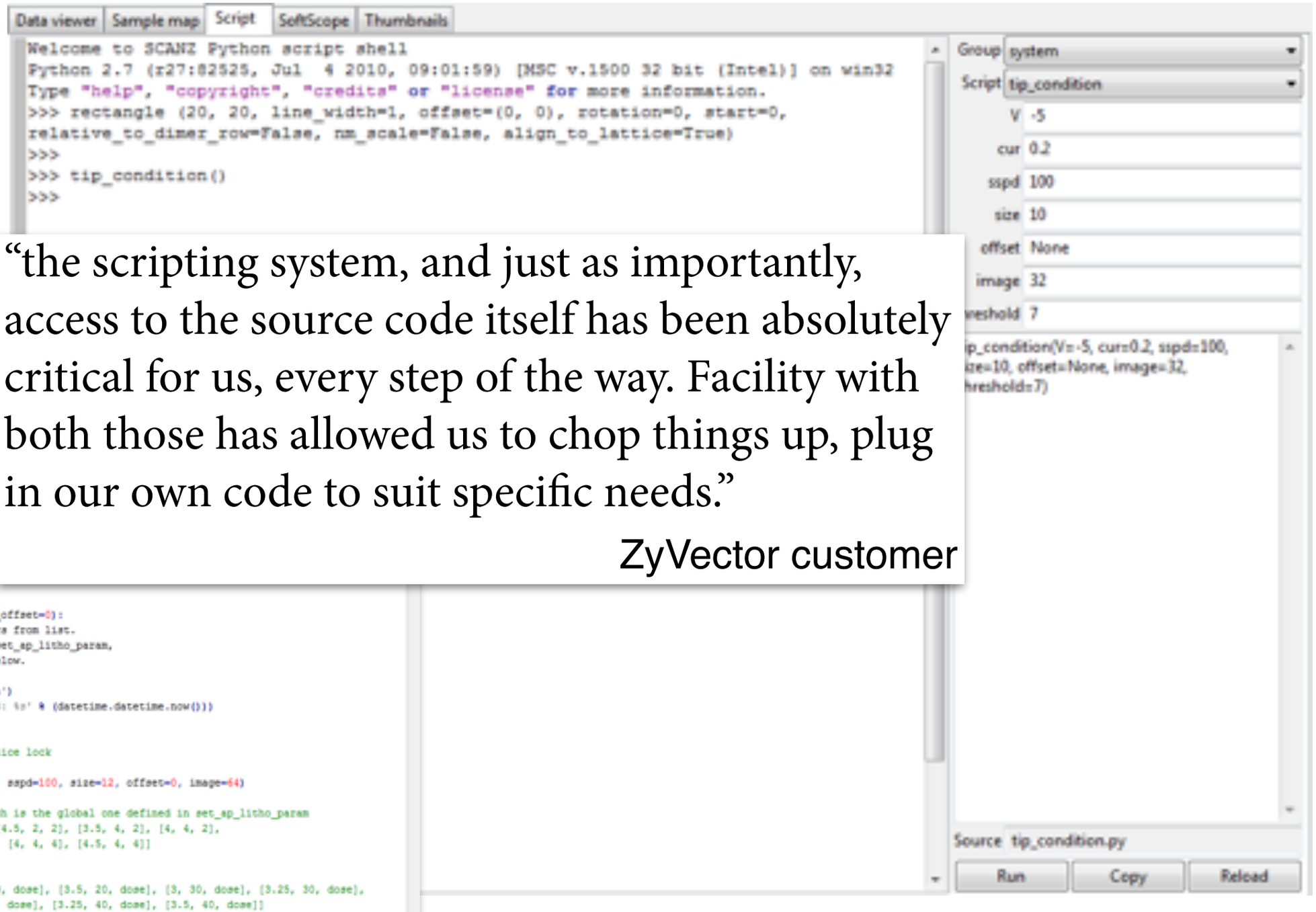


Writing Simple Patterns



Simple shapes can be selected in the GUI and drawn with one click.

Automation through Scripting



"the scripting system, and just as importantly, access to the source code itself has been absolutely critical for us, every step of the way. Facility with both those has allowed us to chop things up, plug in our own code to suit specific needs."

ZyVector customer

Writing complex patterns

1.

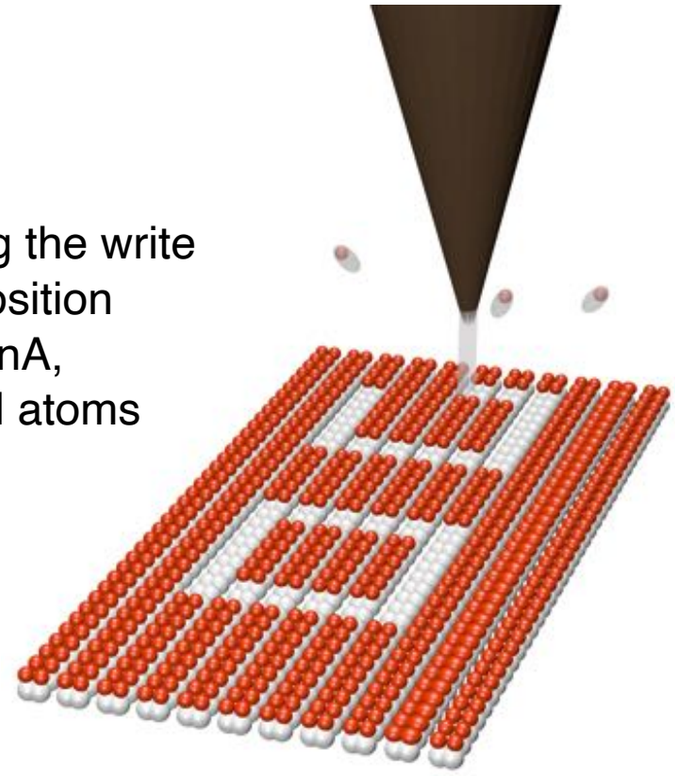
Pattern File comprises black-and-white bitmap input file.

2.

ZyVector converts the pattern file into write vectors, following the Si(001) lattice.

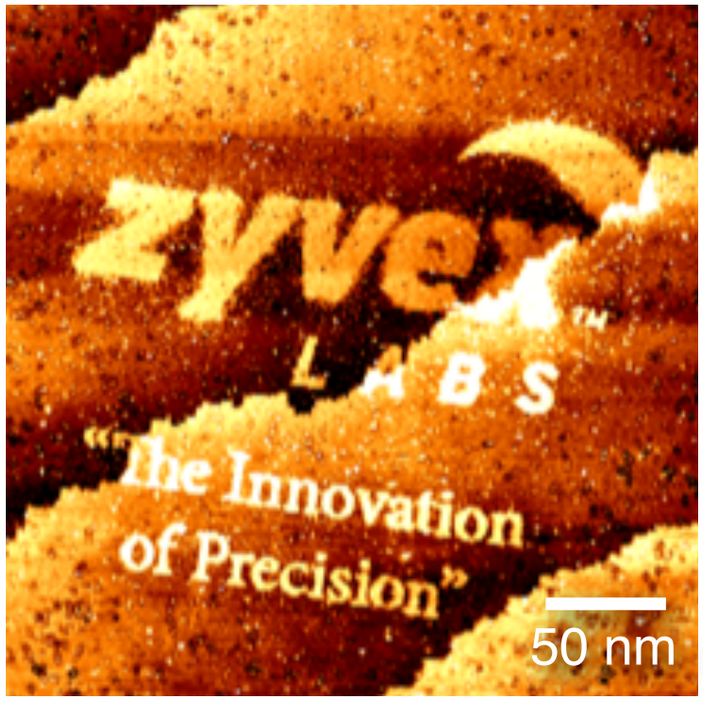
3.

STM tip moves along the write vectors with 1.5 Å position precision at 4.5 V, 4 nA, 20 nm/s, removing H atoms

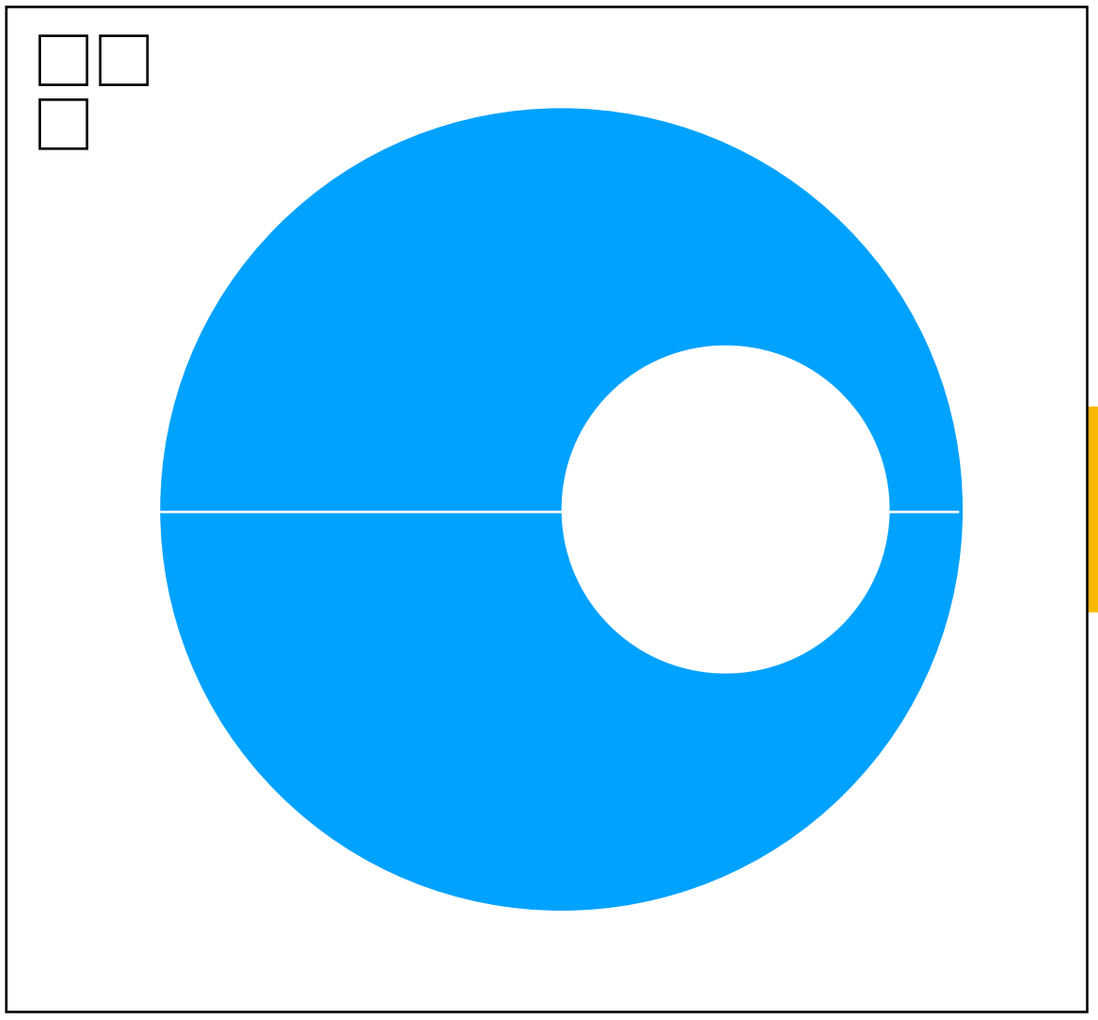


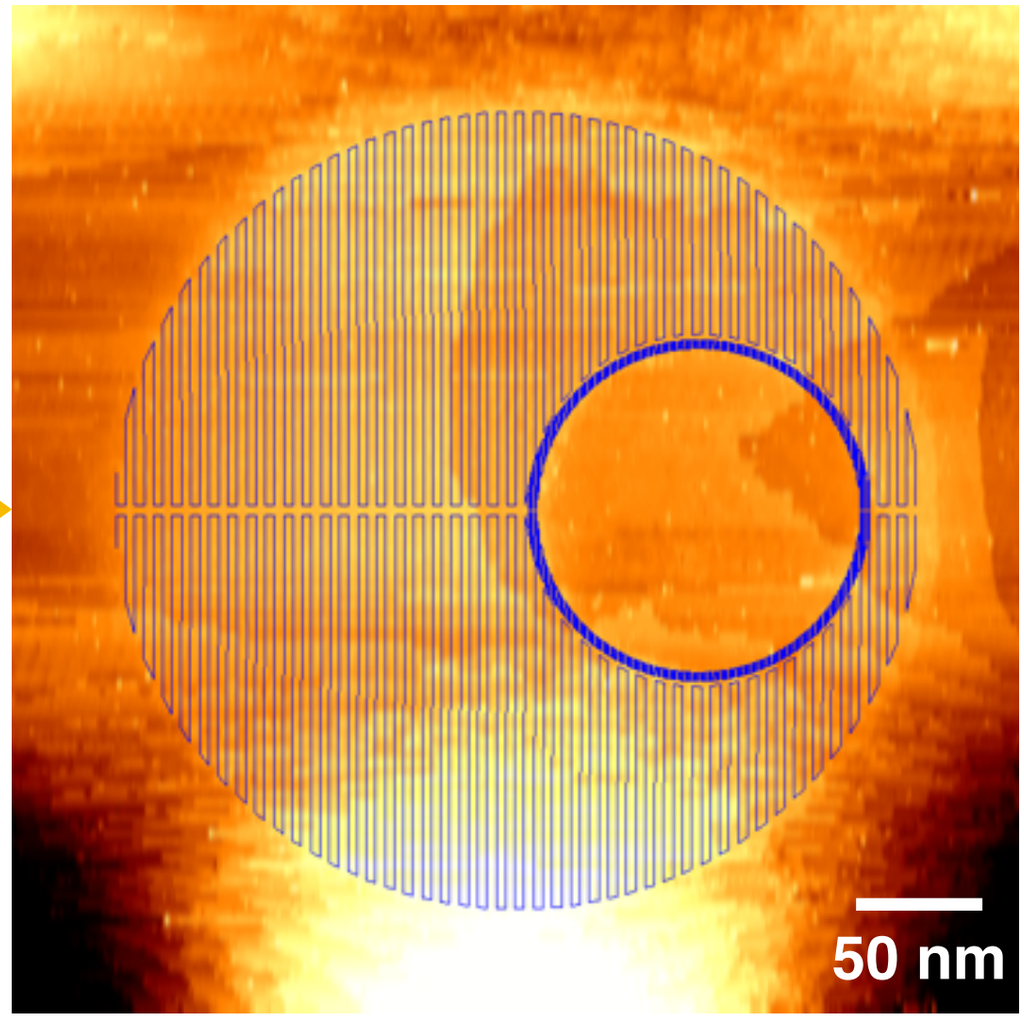
4.

The final atomic-resolution pattern of exposed Si dangling bonds



Complex patterns from a CAD file.

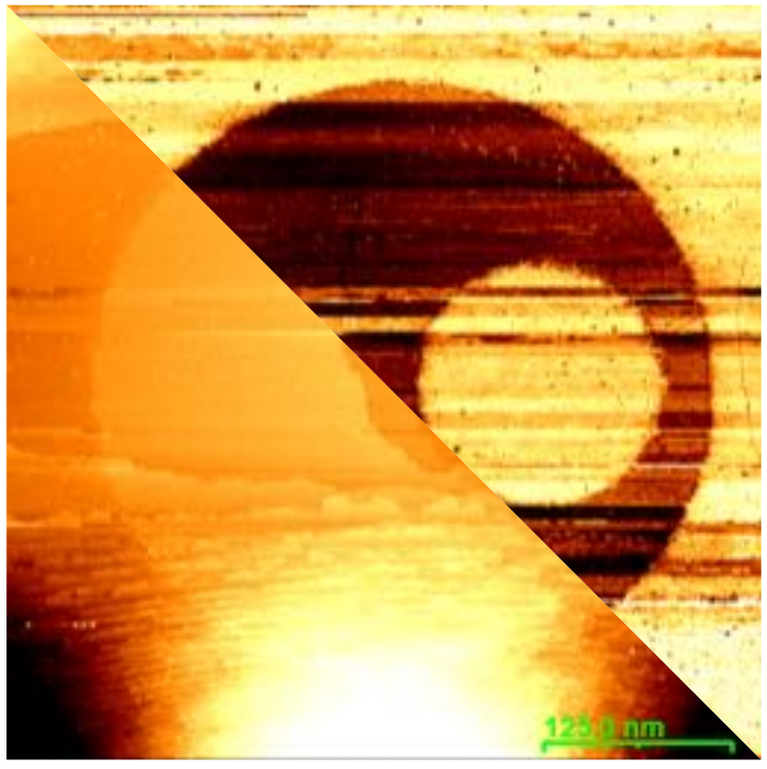




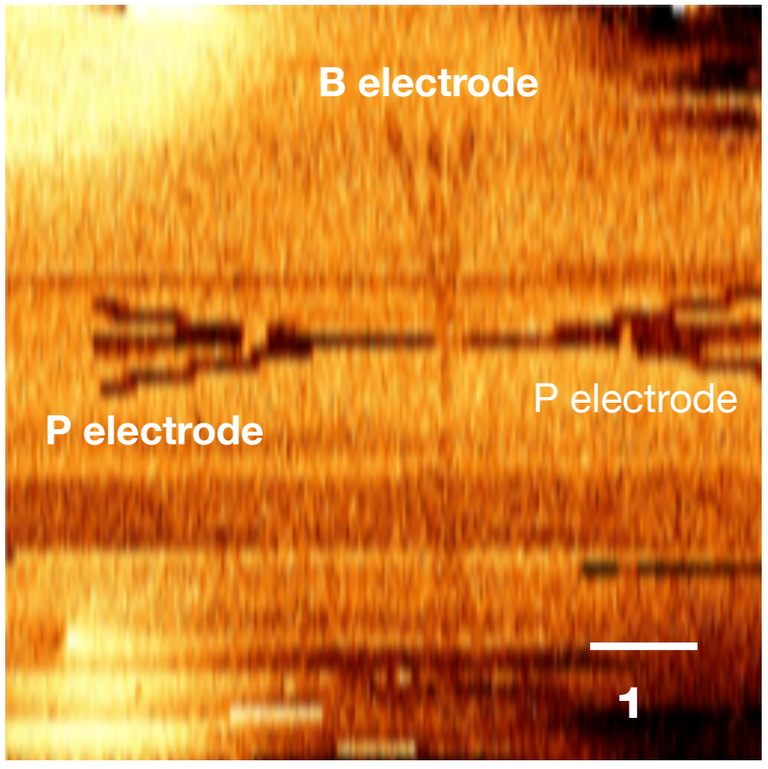
Design in CAD software → to DXF → DXF lab conversion software → to SVG → Inkscape
Verify scale
Define centre point
Define litho conditions → input → ZyVector pattern file

A CAD file can also be used as a pattern input file via an SVG file.

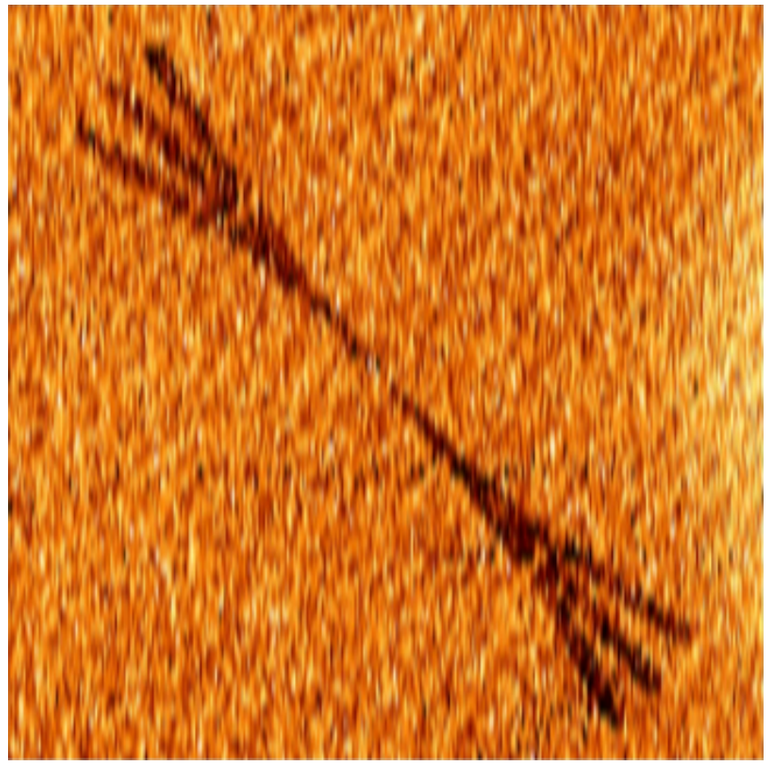
Image modes for pattern detection



As dI/dZ is a measure of the surface electronic properties, it shows surface features such as lithography patches with good contrast, even on rough surfaces, where topography is lost.



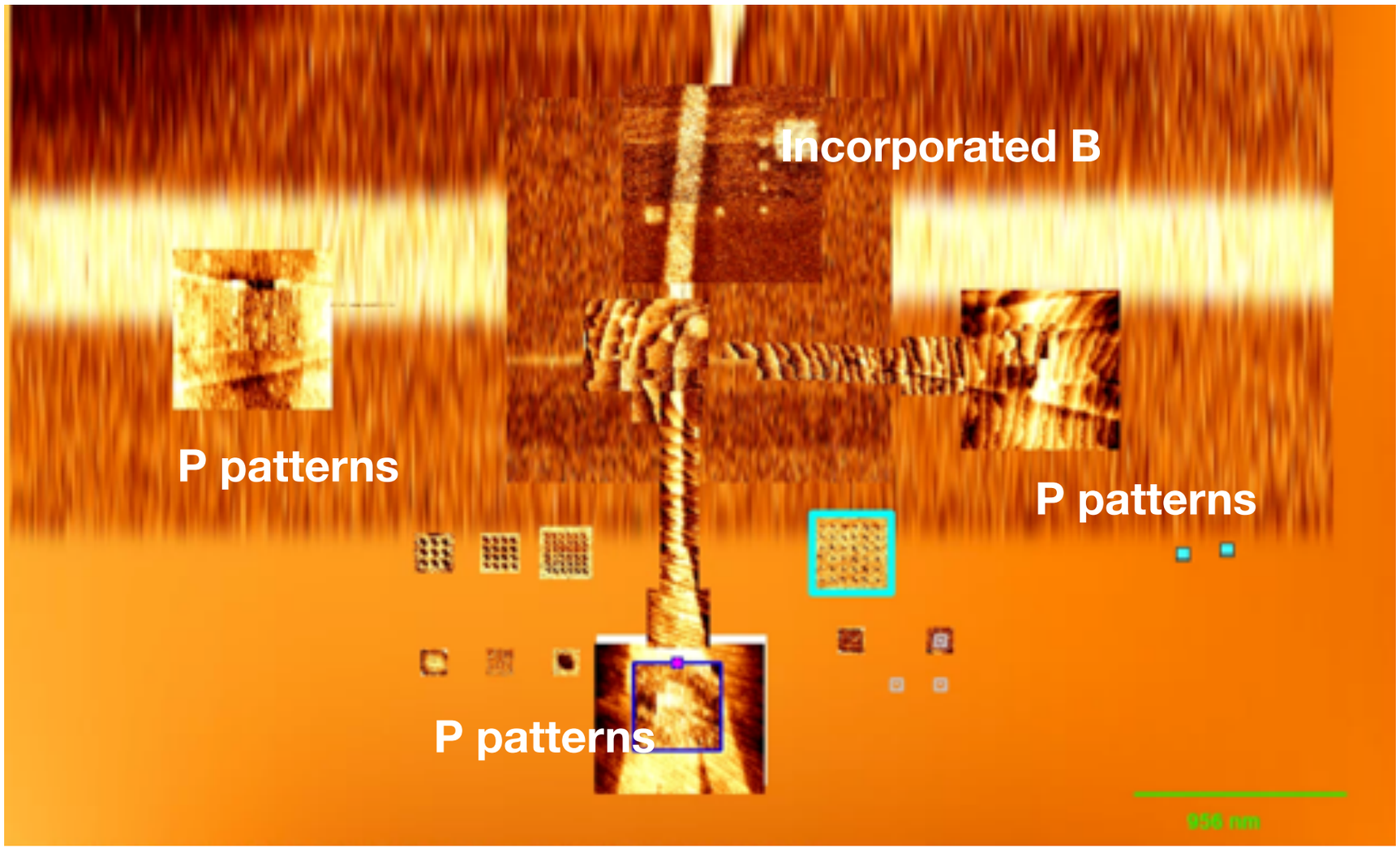
After incorporation



20 nm overgrowth

For observing buried structures, we use dI/dV imaging to give contrast of the P-doped and B-doped regions, even under 20 nm of overgrown Si.

Powerful GUI for complex patterning



- The Sample Map GUI shows the relative position of different images and patterns. Topography, dI/dz and dI/dV images can be combined here.

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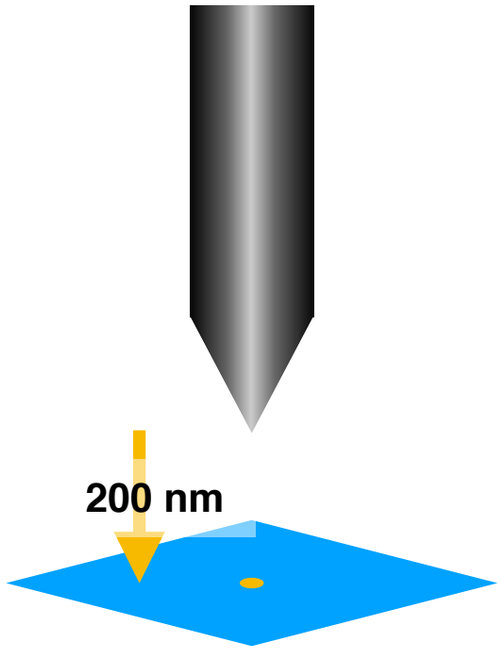
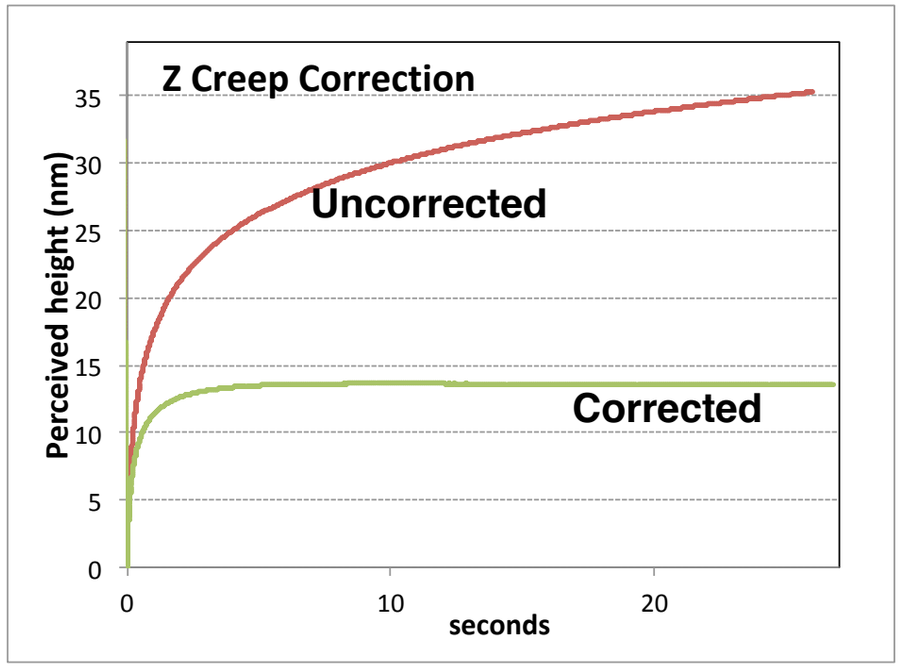
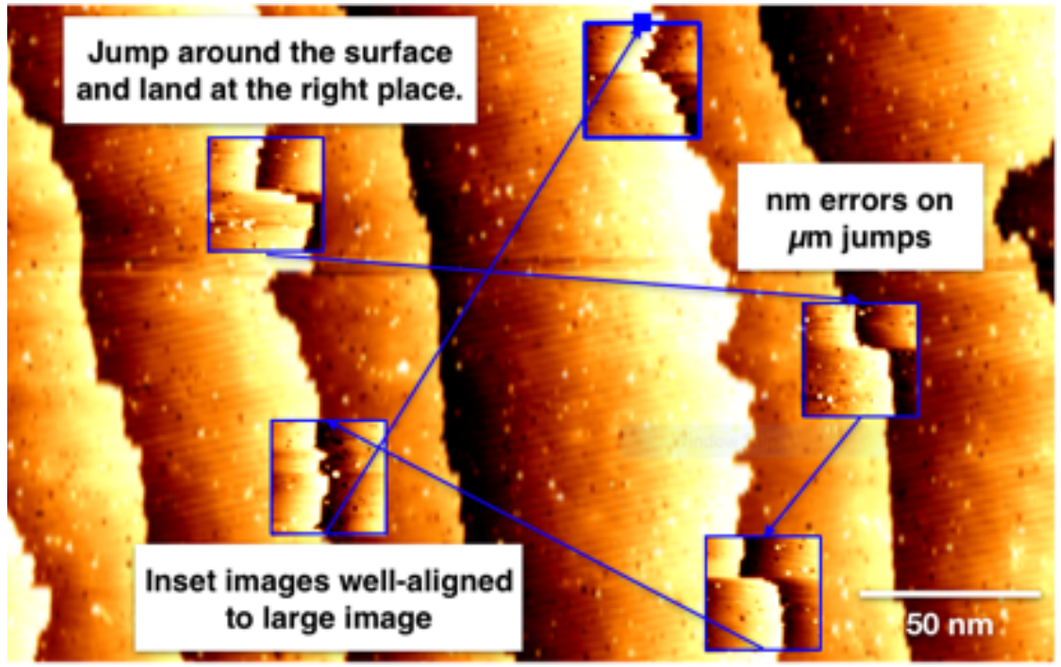
CHC: real-time position correction







- CHC – creep and hysteresis correction – is used to correct tip motion on ZyVector.
- Automated drift correction is also included in ZyVector.
- Z creep, instead of taking minutes or hours to settle, takes seconds.
- For *μ*m-scale jumps, hysteresis errors reduced from 100's nm to nm.

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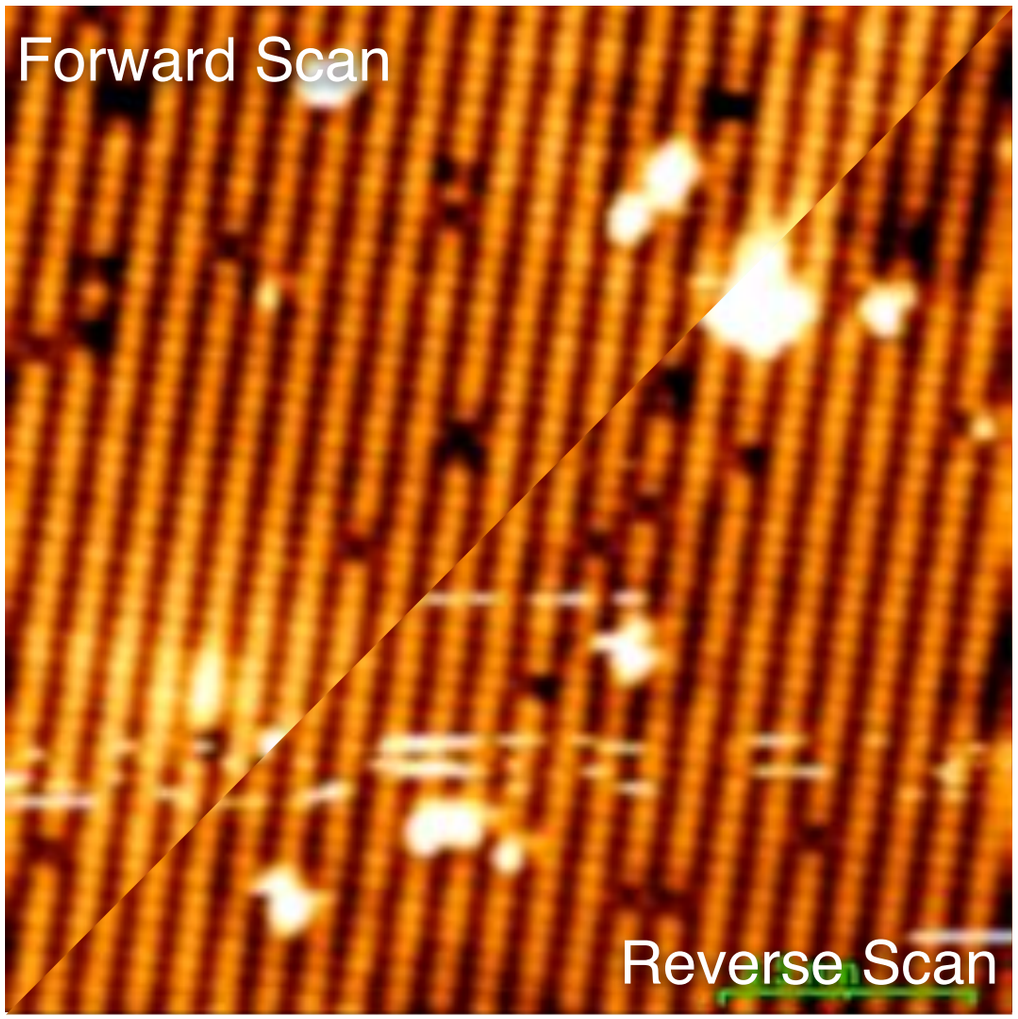
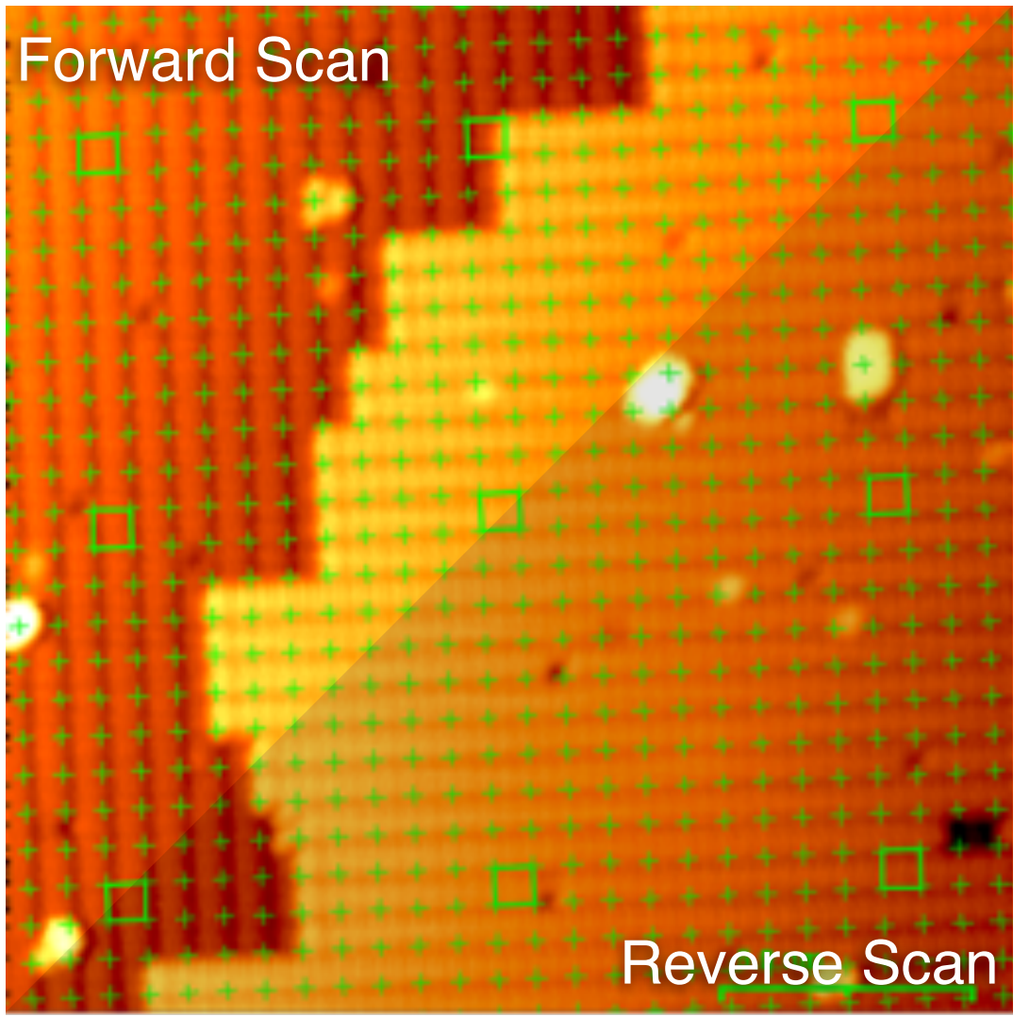
Distortion-free Imaging

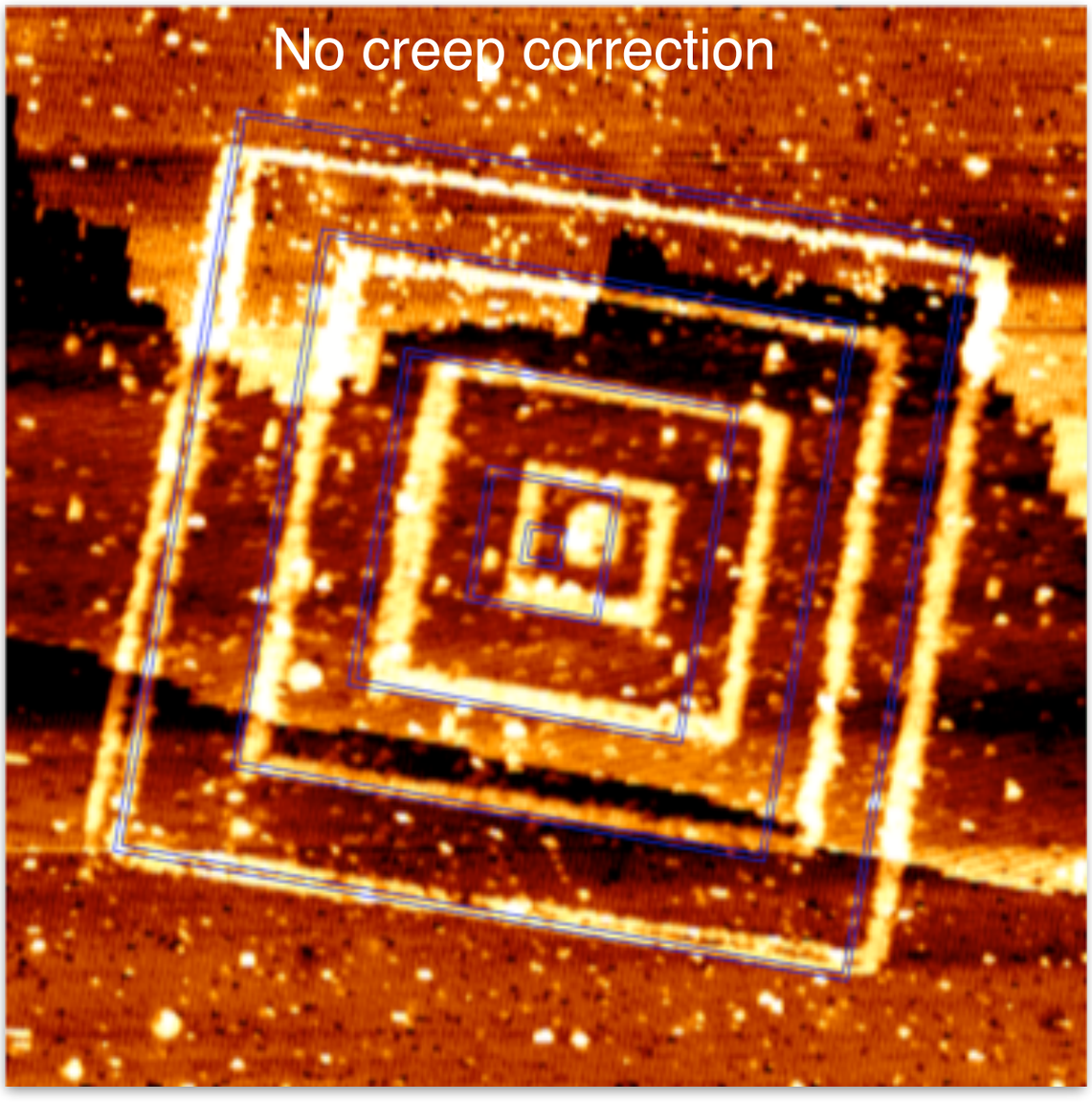


No creep correction:
Forward/Backward offset : 3.6 Å

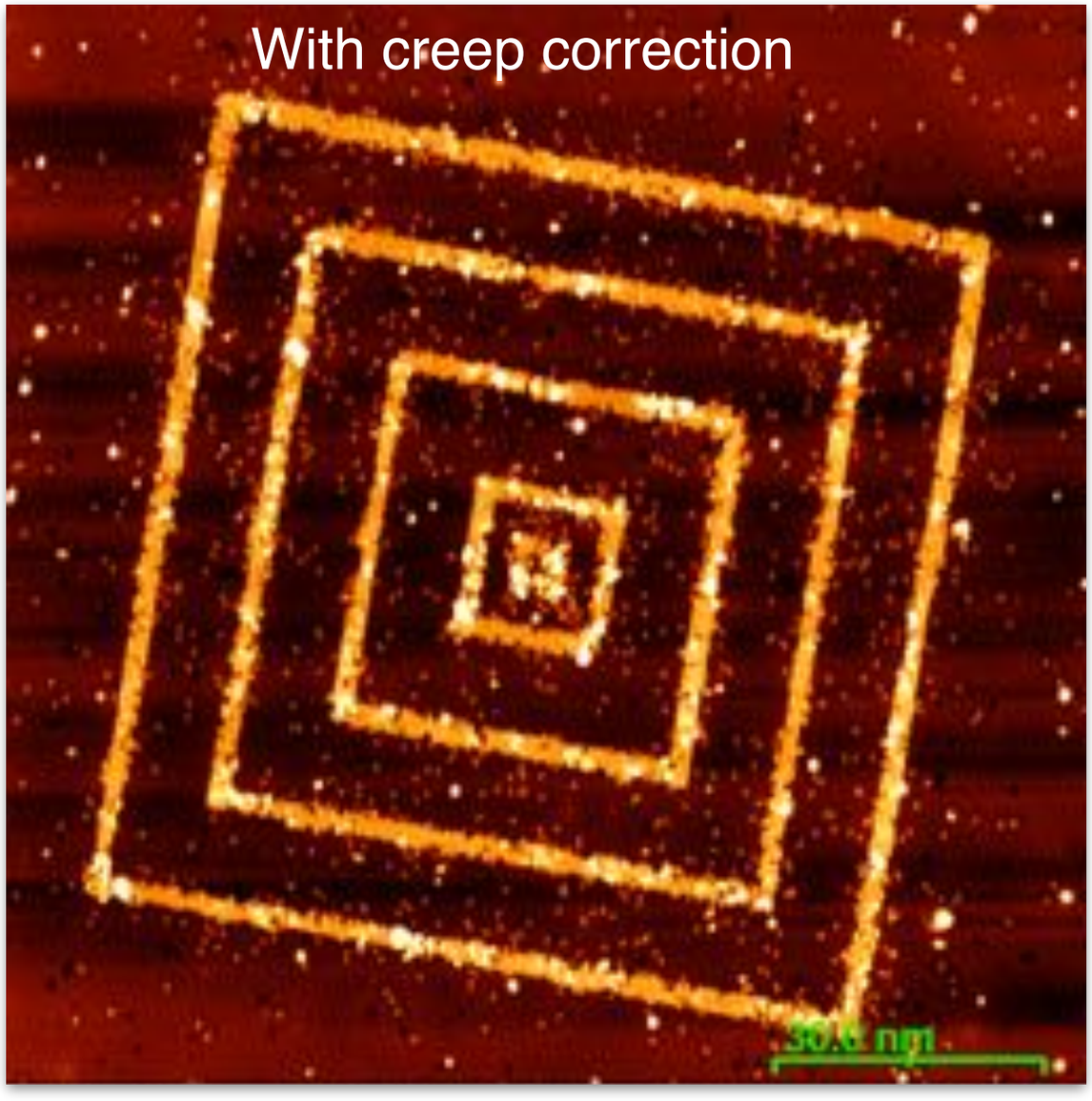


Corrected creep:
Forward/Backward offset: 0 Å

Creep correction for patterning

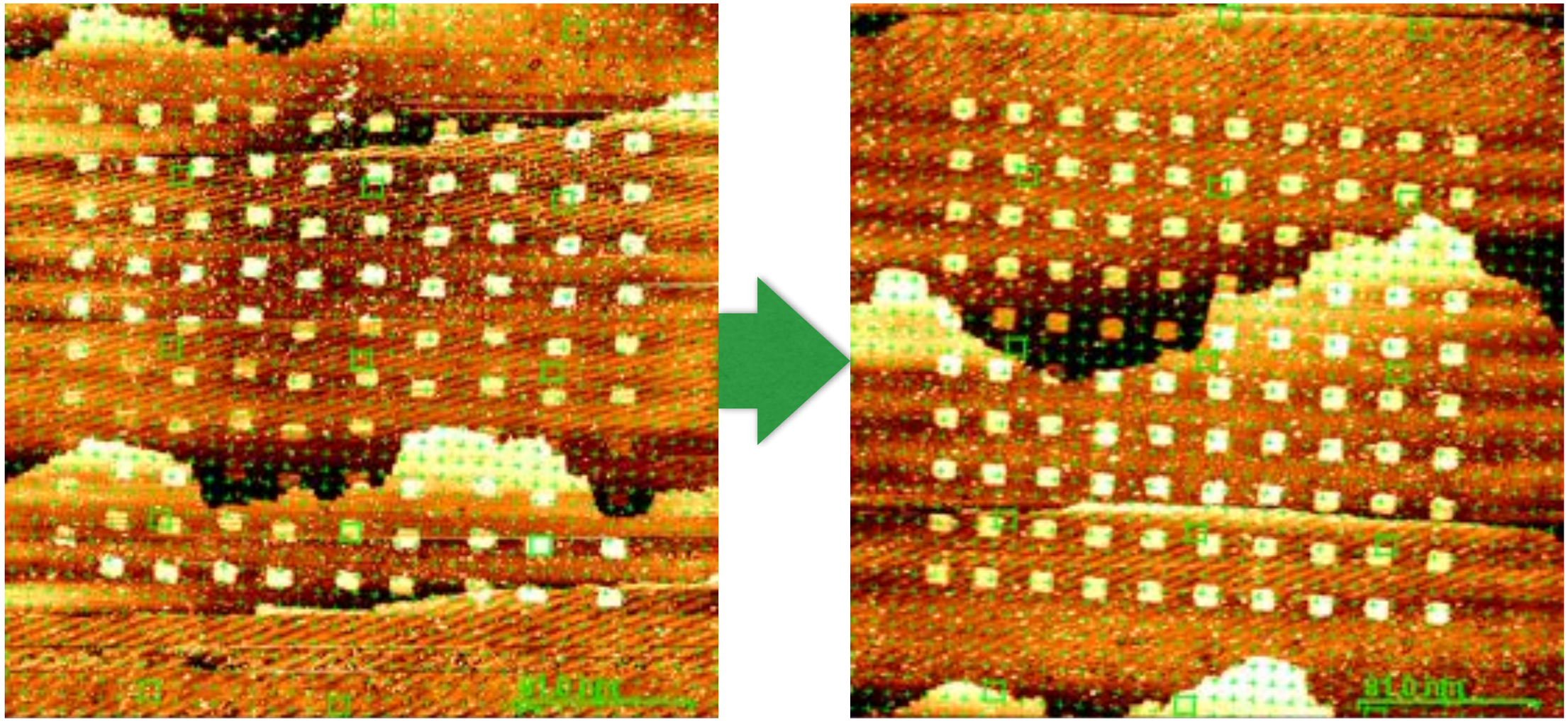


Paired lines are not adjacent.
Squares are not square.
Squares are not concentric.



Paired lines adjacent.
Squares are square.
Squares are concentric.

Atomically Precise Arrays



Drawing arrays of boxes for quantum devices is a hard alignment problem.

Automated array drawing requires careful correction not only of creep, but also thermal drift and hysteresis.
The box position error here is at most 1 px – 0.768 nm.

Softscope - live view of data channels

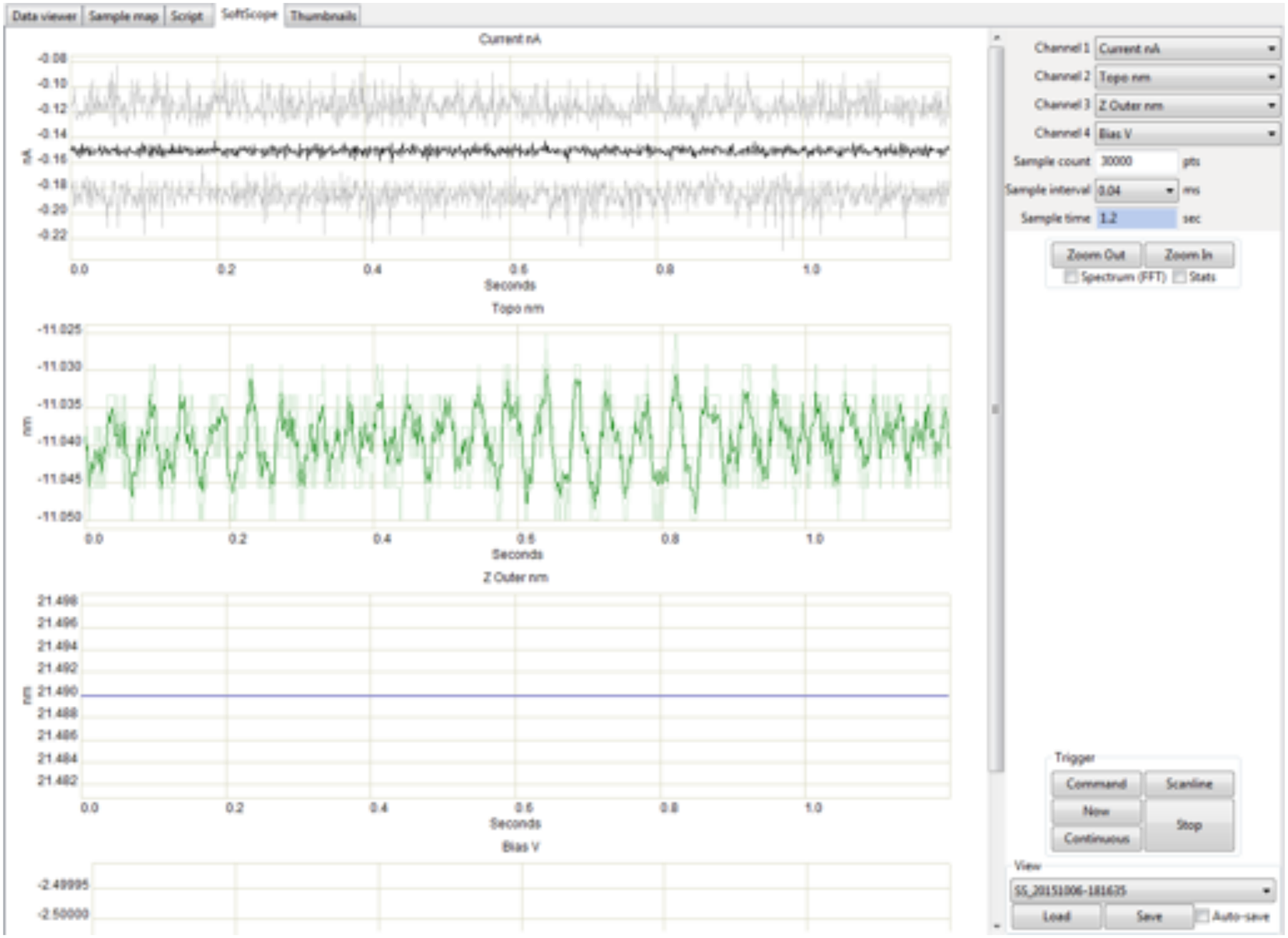


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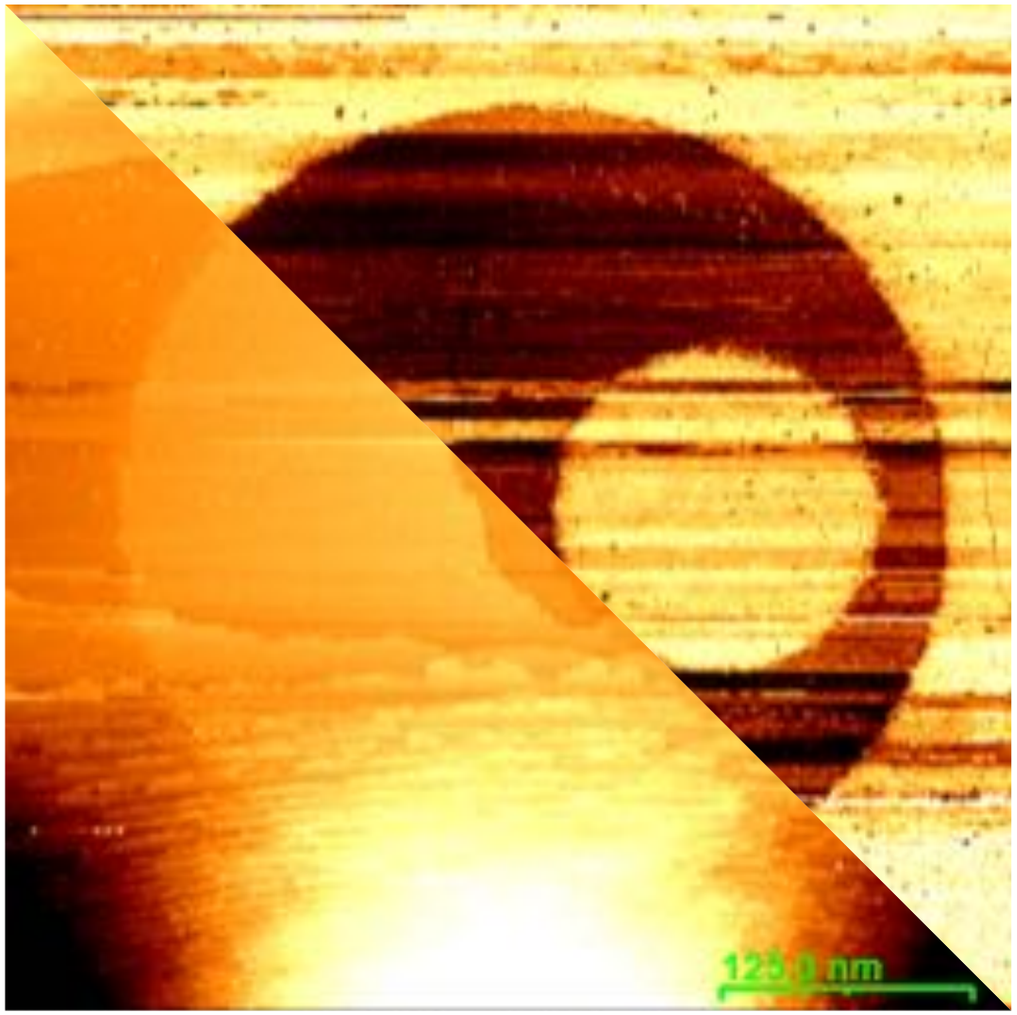
Image modes for pattern detection



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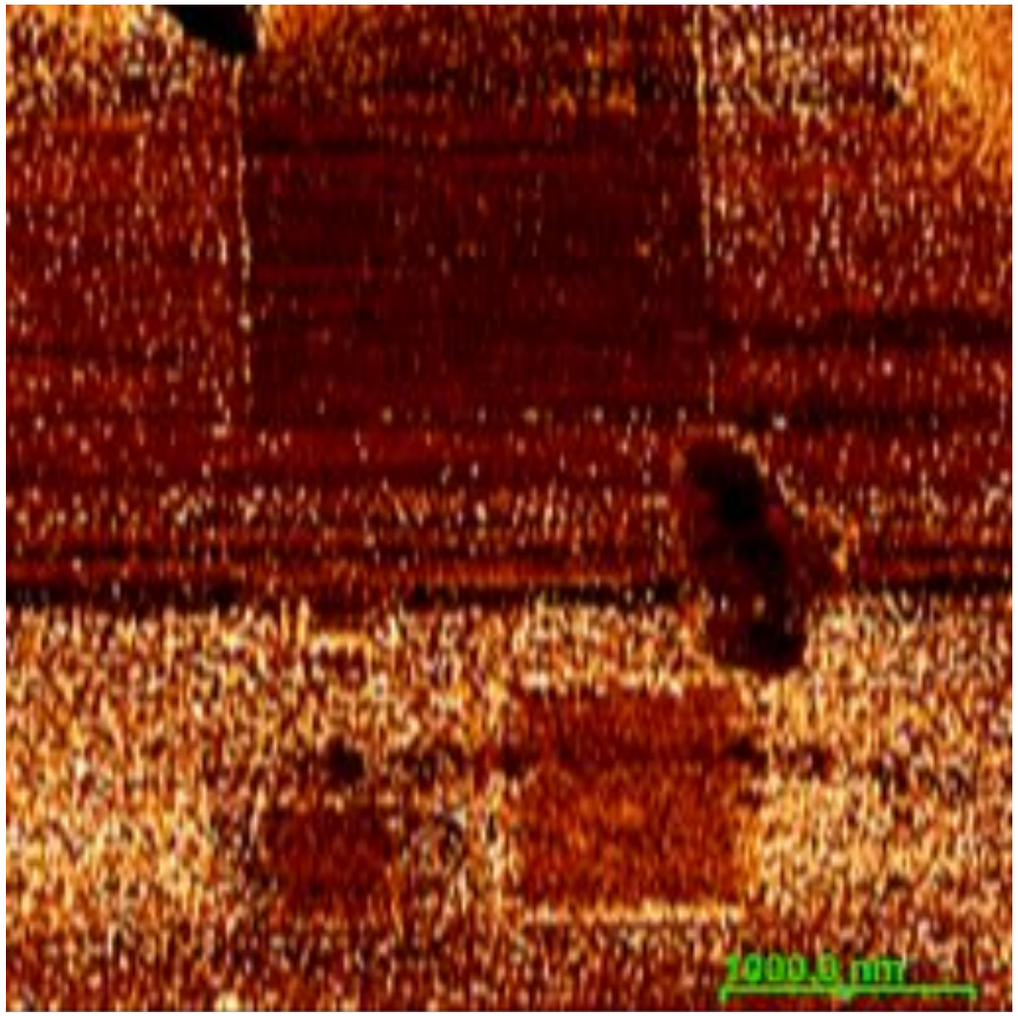
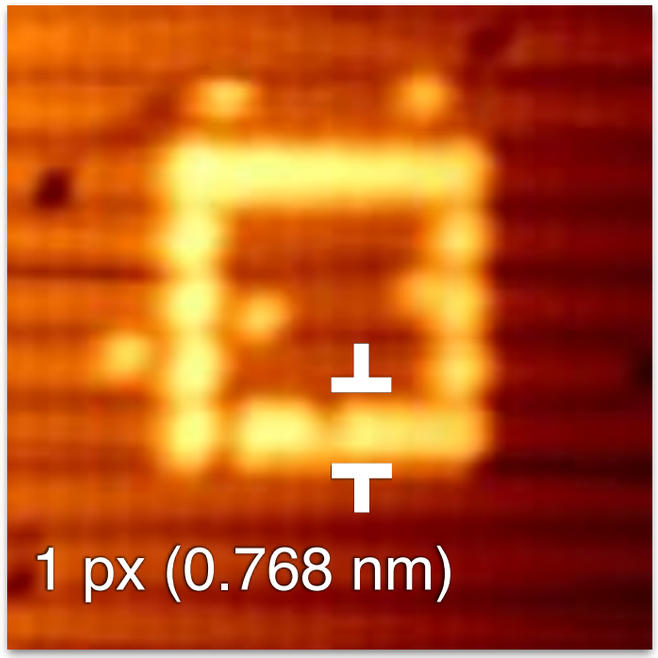
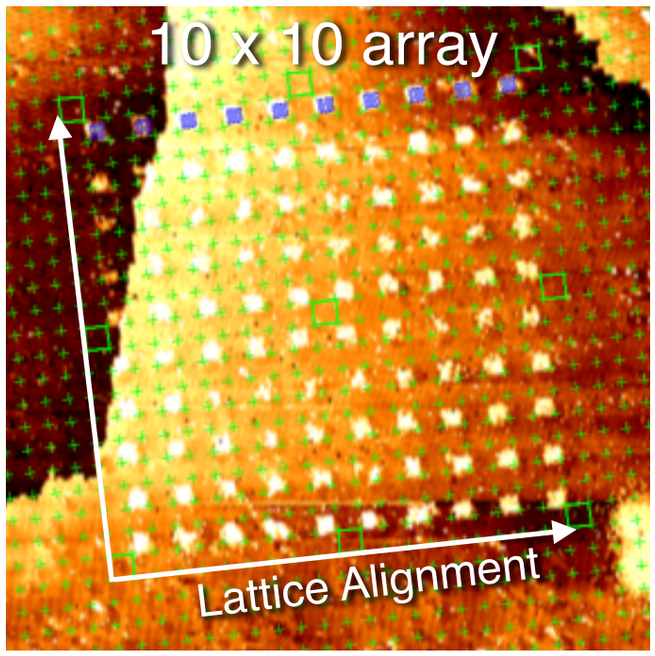
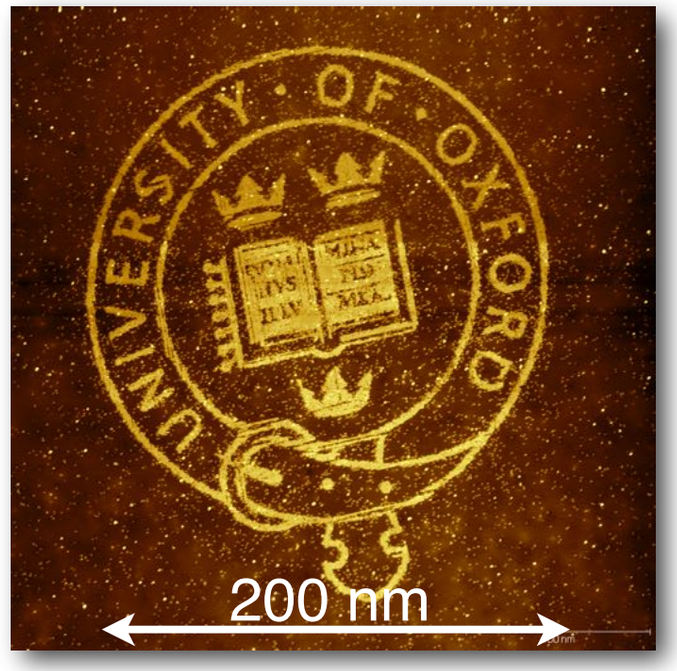


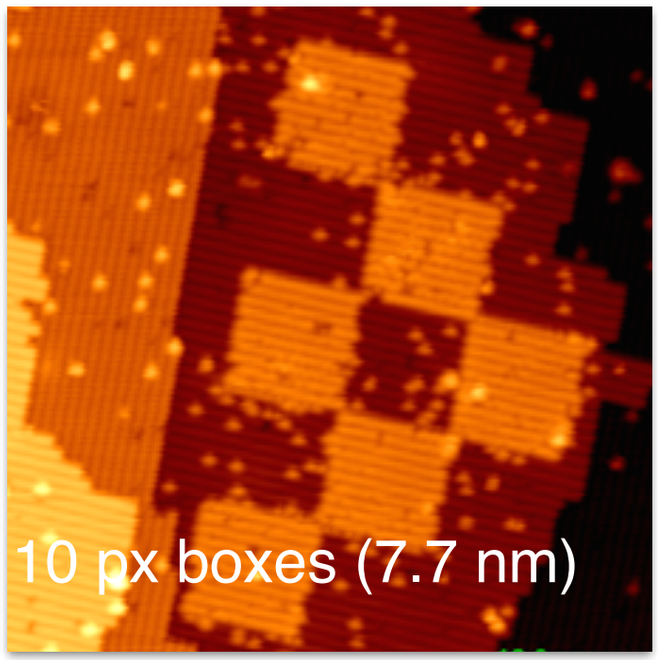
For observing buried structures, we use dI/dV imaging to give contrast of the P-doped regions, even under 20 nm of overgrown Si.

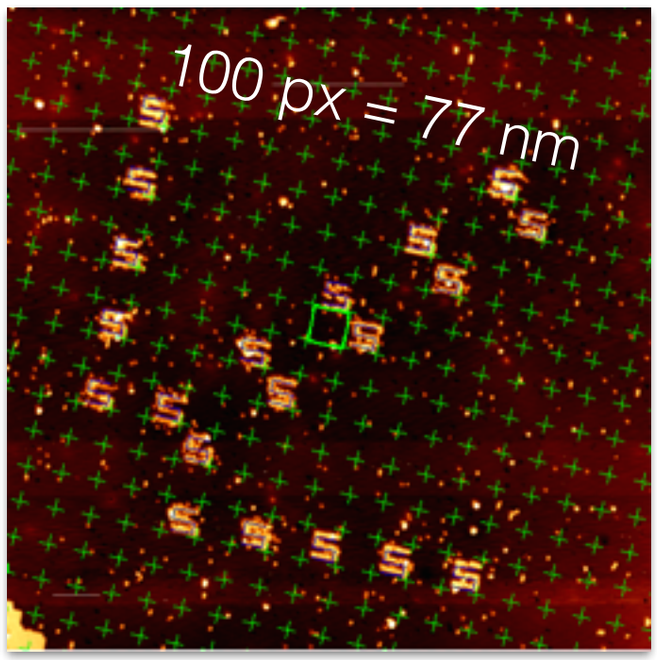
What would you like to draw?

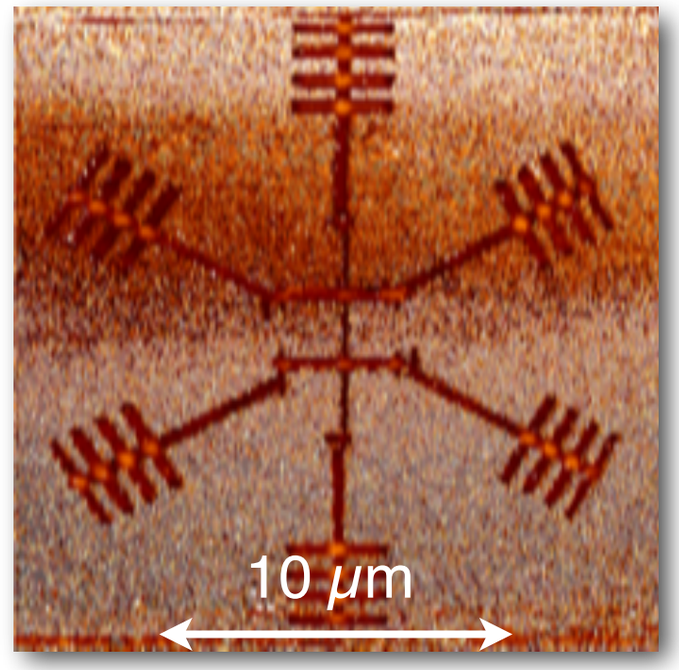












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Powerful scripting allows for lattice-aligned Atomically Precise Patterning